



32 x 2-way Active Wide Band Splitter Shelf

with preset gain and slope compensation


The unit is designed to link ETL's range of matrices to make bigger matrix systems, while saving rack space and offering excellent RF performance.

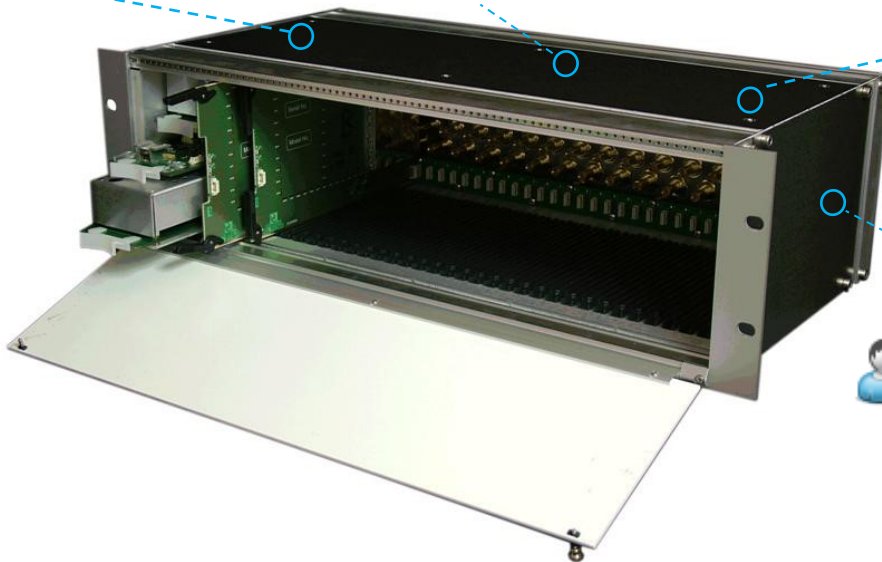
Typical applications:

- Linking RF matrices in expanding satellite teleports.
- Can be used for a high density RF distribution chassis where rack space is limited.
- As a replacement for non hot-swap passive systems to improve system design.

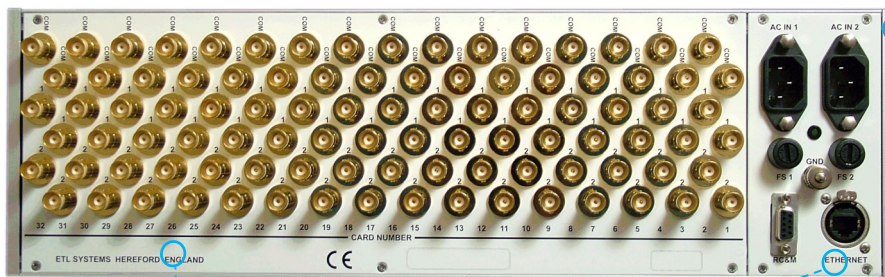
 **Preset gain & slope** to compensate for system losses.

 **50 - 2450 MHz** operating frequency range.


 **Resilience** from dual redundant hot-swap power supplies, hot-swap CPU & Splitter modules




 **Local monitoring** via module LED's



 **Alarms** via LED's and CPU in chassis

 **Remote control & monitoring** via serial and Ethernet ports.

 **Compact** up to 32 splitter modules housed in a 3U high chassis



Technical specifications and operating parameters

Splitter Module—Technical Specifications and operating parameters					
Frequency Range	50 to 2450 MHz				
Gain	x±1 dB	X=0 to 10 dB Nominal at 2450 MHz			
Slope	y dB positive slope	Y=0 to +6 dB, Typical slope across 50 to 2450 MHz			
Impedance & RF Connectors	50Ω SMA	50Ω BNC	75Ω BNC	75Ω F-type	
Gain Flatness	Full Band With ref to slope trendline	±0.75 dB	±0.75 dB	±0.75 dB	±1.0 dB
	Any 36 MHz	±0.45 dB	±0.45 dB	±0.45 dB	±0.7 dB
Input Return Loss	Typical	16 dB	14 dB	12 dB	10 dB
	Minimum	12 dB	12 dB	10 dB	8 dB
Output Return Loss	Typical	16 dB	14 dB	12 dB	10 dB
	Minimum	12 dB	12 dB	10 dB	8 dB
Card to Card Isolation	>70 dB, typically 80 dB				
Output to Output Isolation	>20 dB, typically 25 dB, Individual Card				
Noise Figure	11 dB Typical				
1dB GCP	+3 dBm minimum				
Input RF Power	+16 dBm Absolute maximum				
Power Consumption per Card	475 mW per card				
Operating Temperature	Operating: 0 to 45°C / Storage: -20°C to +75°C				
Humidity	20 to 90% non-condensing				
Local Control & Monitor	LED's for Status				
Alarms	Individual module LED and via CPU in Chassis. Also Amplifier status monitoring via HMI when used in a switch matrix system.				
Chassis Specifications					
Capacity	32 x 2-way Splitter modules				
Dimensions	3U high x 250mm deep x 19" wide				
Weight	10 kg				
Colour	White 00-E-55 semi-gloss				
Power Supply	85-264Vac 50-60Hz	Fused 2A, dual IEC			
PSU	Dual Redundant	Diode OR			
Remote Control	Via RS232 & RJ45 Ethernet 10BaseT				
Protocols	Serial (also over TCP/IP), Web Browser & SNMP				
Hot-Swap PSU	Yes				
Power Consumption	30W	Fully populated with DIV26 cards			

Note 1: The specification is subject to regular reviews and will be updated from time to time as part of our continuing product development and improved spec accuracy.
 Note 2: Operation beyond the quoted limits stated above may cause instantaneous and permanent damage.

